

# 30 Volt P-Channel PowerTrench<sup>®</sup> MOSFET

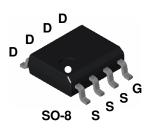
## **General Description**

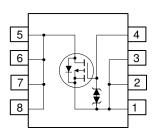
This P-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that has been especially tailored to minimize the on-state resistance.

This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.

## Features

- -20 A, -30 V.  $R_{DS(ON)} = 4.6 \text{ m}\Omega @ V_{GS} = -10 \text{ V}$  $R_{DS(ON)} = 6.5 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$
- + Extended  $V_{\mbox{\scriptsize GSS}}$  range (–25V) for battery applications
- HBM ESD protection level of 8kV typical (note 3)
- + High performance trench technology for extremely low  $R_{\text{DS(ON)}}$
- High power and current handling capability
- Termination is Lead-free and RoHS Compliant





## Absolute Maximum Ratings $T_A=25^{\circ}C$ unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DSS</sub>	Drain-Source Voltage				-30	V
V <sub>GSS</sub>	Gate-So	Gate-Source Voltage			±25	V
ID	Drain Cu	urrent – Continuous		(Note 1a)	-20	A
		<ul> <li>Pulsed</li> </ul>			-105	
PD	Power Dissipation for Single Operation (Note 1a)			(Note 1a)	2.5	W
				(Note 1b)	1.2	
				(Note 1c)	1.0	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			e Bange	-55 to +150	°C
Therma	al Chara	acteristics		ī		
Therma	al Chara Thermal		-to-Ambient	(Note 1a) (Note 1)	50 25	°C/W
<b>Therma</b> R <sub>0JA</sub> R <sub>0JC</sub>	Thermal	acteristics Resistance, Junction	-to-Ambient -to-Case	(Note 1a) (Note 1)	50	°C/W
Therma R <sub>θJA</sub> R <sub>θJC</sub>	al Chara Thermal Thermal	acteristics Resistance, Junction Resistance, Junction	-to-Ambient -to-Case	(Note 1a) (Note 1) mation	50	°C/W °C/W Quantity

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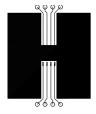
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
•				- 71-		
	Acteristics		00			V
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$ , $I_D = -250 \mu A$	-30		-	v
<u>ΔBV<sub>DSS</sub></u> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C		-26		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -24 V, V_{GS} = 0 V$			-1	μA
I <sub>GSS</sub>	Gate-Body Leakage	$V_{\text{GS}} = \pm 25 \ V,  V_{\text{DS}} = 0 \ V$			±10	μA
On Chara	Acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-1	-1.8	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		6		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source	$V_{GS} = -10 V, I_D = -20 A$		3.8	4.6	mΩ
	On-Resistance	$V_{GS} = -4.5 \text{ V}, \ I_D = -17 \text{ A}$		5.2	6.5	
		$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -20 \text{ A}, \text{T}_{J} = 125^{\circ}\text{C}$		5.0	6.3	
<b>g</b> fs	Forward Transconductance	$V_{\text{DS}} = -5 \text{ V},  I_{\text{D}} = -20 \text{ A}$		79		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -15 V$ , $V_{GS} = 0 V$ ,		7540		pF
Coss	Output Capacitance	f = 1.0 MHz		1400		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			1120		pF
Switchin	g Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn–On Delay Time	$V_{DD} = -15 V$ , $I_D = -1 A$ ,		20	35	ns
tr	Turn–On Rise Time	$V_{GS} = -10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		9	18	ns
$t_{\text{d(off)}}$	Turn–Off Delay Time	7		660	1060	ns
t <sub>f</sub>	Turn-Off Fall Time	7		380	610	ns
$Q_{g(\text{TOT})}$	Total Gate Charge at $V_{GS} = -10V$	$V_{DS} = -15 \text{ V}, I_{D} = -20 \text{ A}$		185	260	nC
$Q_{g(\text{TOT})}$	Total Gate Charge at $V_{GS} = -5V$			105	150	nC
Q <sub>gs</sub>	Gate-Source Charge			26		nC
Q <sub>gd</sub>	Gate-Drain Charge	7		47		nC

			1	1	1	
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain–So	urce Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain-Sour	ce Diode Forward Current			-2.1	Α
V <sub>SD</sub>	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$ , $I_{S} = -2.1 A$ (Note 2)		-0.7	-1.2	V
t <sub>RR</sub>	Reverse Recovery Time	I <sub>F</sub> = -20 A,		125		ns
Q <sub>RR</sub>	Reverse Recovery Charge	dl <sub>F</sub> /dt = 100 A/µs (Note 2)		94		nC

#### Notes

1. R<sub>6JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta CA}$  is determined by the user's board design.



a) 50°C/W (10 sec)
 62.5°C/W steady state when mounted on a 1in<sup>2</sup> pad of 2 oz copper

Q Q Q Q Qb) 105°C/W when mounted on a .04 in<sup>2</sup> pad of 2 oz copper 

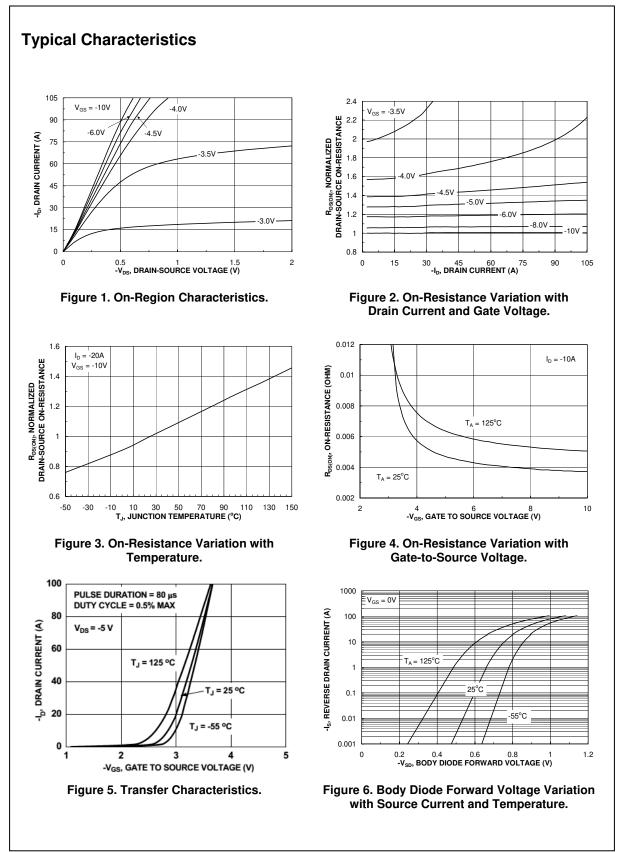
c) 125°C/W when mounted on a minimum pad.

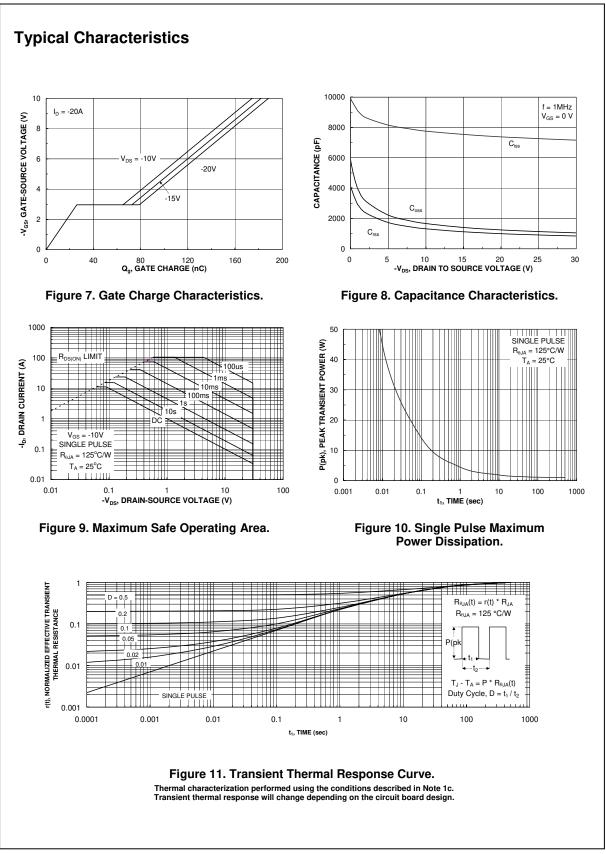
Scale 1 : 1 on letter size paper

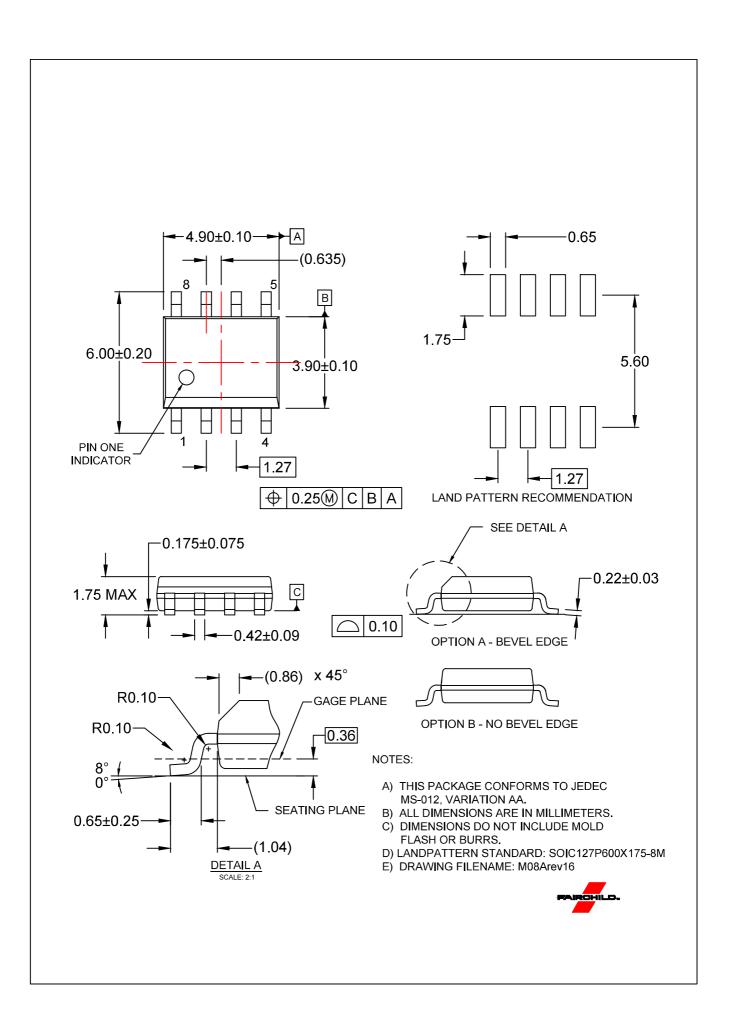
2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty Cycle < 2.0%

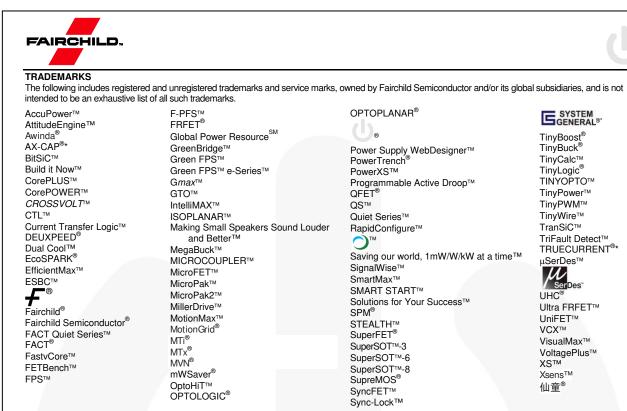
3. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

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